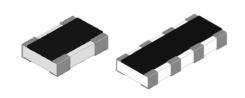
Stackpole Electronics, Inc.

Flat Termination Chip Resistor Array

Resistive Product Solutions

Features:

- Thick film resistor element
- Ideal SMD substitute for leaded networks
- Flat termination for better solderability, reliability and lower cost
- Zero ohm jumper available
- RoHS compliant, REACH compliant, and halogen free



| Electrical Specifications | | | | | | | | | |
|---|---------------------|--------------------------------|----------------------------|---------------------|-----------------|----------------|------------------|--|--|
| Type / Code (# of Elements/Circuit Type) | Number of Resistors | Power Rating (W) (per element) | Maximum Working | Maximum Overload | TCR (ppm/°C) | Ohmic Range (Ω | Ω) and Tolerance | | |
| | 1103131013 | @ 70°C | Voltage (V) ⁽¹⁾ | Voltage (V) | (ррпі/ О) | 1% | 5% | | |
| RAF052D | 2 | 0.031 | 12.5 | 25 | ± 300 | - | 3 - 9.1 | | |
| KAF032D | 2 | 0.031 | 12.5 | 25 | ± 200 | 10 - | · 1M | | |
| RAF054D | 4 | 0.031 | 12.5 | 25 | ± 200 | 10 - 1M | | | |

(1) Lesser of $\sqrt{P^*R}$ or maximum working voltage

| | Schematics | | | | | | | | | | |
|---|-----------------------|------------------------------|--------------------------------------|------------------------------|------------------------------|--------------------------------------|------------------------------|------------------------------|--------------|--|--|
| Isolated Circuit - | - 2D Isola | 4 Resistors / 8 | Terminations (D) | | | | | | | | |
| 4 3 | 8 | 5 | -A- | C C | Y W | A B | L | C H | ‡ † w | | |
| | | | Mec | hanical Spe | ecifications | | | | | | |
| Type / Code (# of Elements/ Circuit Type) | Weight (g) (1000 pcs) | L Body Length | W Body Width | H Body Heith | A Termination Width | B Element Spacing | C Top Termination | Y Bottom Termination | Unit | | |
| RAF052D | 0.500 | 0.031 ± 0.004 0.80 ± 0.10 | 0.024 ± 0.004 0.60 ± 0.10 | 0.014 ± 0.004 0.35 ± 0.10 | 0.012 ± 0.004 0.30 ± 0.10 | 0.020 ± 0.004 0.50 ± 0.10 | 0.006 ± 0.004 0.15 ± 0.10 | 0.006 ± 0.004 0.15 ± 0.10 | inches mm | | |
| RAF054D | 0.833 | 0.055 ± 0.004 1.40 ± 0.10 | 0.024 ± 0.004 0.60 ± 0.10 | 0.014 ± 0.004 0.35 ± 0.10 | 0.008 ± 0.004 0.20 ± 0.10 | 0.016 ± 0.004 0.40 ± 0.10 | 0.004 ± 0.003 0.10 ± 0.07 | 0.006 ± 0.002 0.15 ± 0.05 | inches mm | | |

| Performance Characteristics | | | | | | | | | |
|-----------------------------|---|--|--------------------|---|------------------------------|--|--|--|--|
| Test | Test Method | Test Condition | Test Specification | | | | | | |
| rest | i est Method | rest Condition | ± 1% | ± 5% | Jumper | | | | |
| Short Time Overload | JIS-C-5201-1 4.13 IEC-60115-1 4.13 | RCWV*2.5 or Max. Overload Voltage whichever is lower for 5 seconds | ± (1.0% + 0.05 Ω) | ± (2.0% + 0.05 Ω) | < 50m Ω | | | | |
| Insulation Resistance | JIS-C-5201-1 4.6 IEC-60115-1 4.6 | Max. Overload Voltage for 1 minute | ≥10G | | | | | | |
| Endurance | JIS-C-5201-1 4.25 IEC-60115-1 4.25.1 | 70±2°C, RCWV for 1000 hours with 1.5 hours "ON" and 0.5 hours "OFF" | ± (2.0% + 0.10 Ω) | ± (3.0% + 0.10 Ω) | < 50m Ω CN-21/41:< 100 mΩ | | | | |
| Damp Heat with Load | JIS-C-5201-1 4.24 IEC-60115-1 4.24 | 40 ± 2°C, 90 ~ 95% R.H., RCWV for 1000 hours with 1.5 hours "ON" and 0.5 hours "OFF" | ± (2.0% + 0.10 Ω) | ± (3.0% + 0.10 Ω) | < 50m Ω | | | | |
| Dry Heat | JIS-C-5201-1 4.23 IEC-60115-1 4.23.2 | at +125 / +155°C for 1000 hours | ± (1.0% + 0.05 Ω) | ± (1.5% + 0.10 Ω) CN-21/41: ± (3.0% + 0.10 Ω) | < 50m Ω CN-21/41:< 100m Ω | | | | |

Resistive Product Solutions

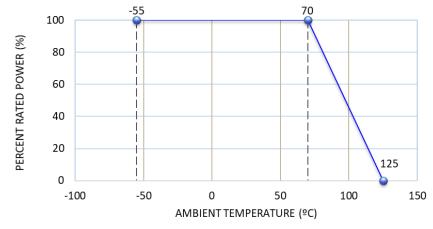
| Performance Characteristics (cont.) | | | | | | | | | |
|-------------------------------------|---|--|---|-------------------|---------|--|--|--|--|
| Test | Test Method | Test Condition | Test Specification | | | | | | |
| rest | r est Method | rest Condition | ± 1% | ± 5% | Jumper | | | | |
| Bending Strength | JIS-C-5201-1 4.33 IEC-60115-1 4.33 | Bending once for 5 seconds with 3 mm | ± (1.0% + 0.05 Ω) | ± (1.0% + 0.05 Ω) | < 50m Ω | | | | |
| Solderability | JIS-C-5201-1 4.17 IEC-60115-1 4.17 | 245 ± 5°C for 3 seconds | 95 % min. coverage | | | | | | |
| Resistance to Soldering Heat | JIS-C-5201-1 4.18 IEC-60115-1 4.18 | 260 ± 5°C for 10 seconds | ± (0.5% + 0.05 Ω) | ± (1.0% + 0.05 Ω) | < 50m Ω | | | | |
| Voltage Proof | JIS-C-5201-1 4.7 IEC-60115-1 4.7 | 1.42 times Max. Operating Voltage for 1 minute | No breakdown or flashover | | | | | | |
| Leaching | JIS-C-5201-1 4.18 IEC-60068-2-58 8.2.1 | 260 ± 5°C for 30 seconds | Individual leaching area ≤ 5% Total leaching are ≤ 10% | | | | | | |
| Rapid Change of Temperature | JIS-C-5201-1 4.19 IEC-60115-1 4.19 | -55°C to +125 / +155°C, 5 cycles | ± (0.5% + 0.05 Ω) | ± (1.0% + 0.05 Ω) | < 50m Ω | | | | |

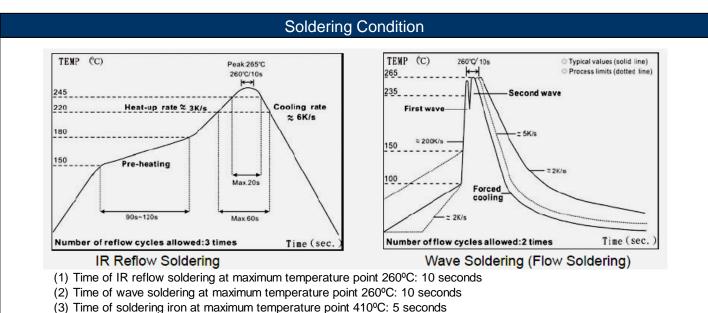
RCWV (Rated Continuous Working Voltage) = $\sqrt{P^*R}$ or Max. Operating Voltage whichever is lower.

Operating Temperature Range: -55°C +125°C, 25°C is the reference temperature

Storage Temperature: 25 ± 3°C; Humidity < 80% RH

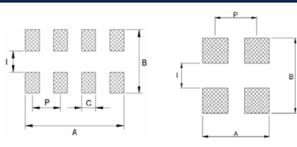
Power Derating Curve:





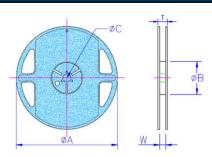
Resistive Product Solutions

Recommended Pad Layout



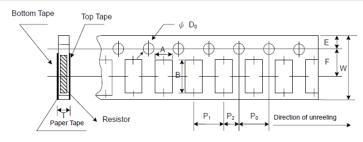
| | Type/Code | A | В | С | 1 | Р | Unit |
|---|-----------|-------|-------|-------|-------|-------|--------|
| Γ | RAF052D | 0.031 | 0.035 | _ | 0.012 | 0.020 | inches |
| | KAFUSZD | 0.80 | 0.90 | - | 0.30 | 0.50 | mm |
| | RAF054D | 0.055 | 0.035 | 0.008 | 0.012 | 0.016 | inches |
| | KAFU04D | 1.40 | 0.90 | 0.20 | 0.30 | 0.40 | mm |

Packaging Information



| Type/Code | Packaging | Quantity | Tape Width | Reel Diameter | А | В | С | W | Т | Unit |
|--------------------|-----------|----------|---------------|------------------|---|-------------------------------|-------------------------------|---|-------------------------------|--------------|
| RAF052D RAF054D | Paper | 10000 | 0.315 8.00 | 7.000 177.80 | | 2.362 ± 0.039 60.00 ± 1.00 | 0.512 ± 0.008 13.00 ± 0.20 | | 0.492 ± 0.020 12.50 ± 0.50 | inches mm |

Paper Tape Specifications



| Type/Code | А | В | W | Е | F | | P0 | Unit |
|-----------|-------------------|-------------------|-------------------|-------------------|---------|-------|-----------------|--------|
| RAF052D | 0.030 ± 0.002 | 0.038 ± 0.002 | 0.315 ± 0.008 | 0.069 ± 0.004 | 0.138 ± | 0.002 | 0.157 ± 0.004 | inches |
| IVAI 032D | 0.77 ± 0.05 | 0.97 ± 0.05 | 8.00 ± 0.20 | 1.75 ± 0.10 | 3.50 ± | 0.05 | 4.00 ± 0.10 | mm |
| RAF054D | 0.030 ± 0.002 | 0.062 ± 0.002 | 0.315 ± 0.008 | 0.069 ± 0.004 | 0.138 ± | 0.002 | 0.157 ± 0.004 | inches |
| KAF034D | 0.77 ± 0.05 | 1.57 ± 0.05 | 8.00 ± 0.20 | 1.75 ± 0.10 | 3.50 ± | 0.05 | 4.00 ± 0.10 | mm |
| Type/Code | P1 | P2 | D0 | T | Unit | | | |
| DAE0E3D | 0.079 ± 0.002 | 0.079 ± 0.002 | 0.059 ± 0.004 | 0.020 ± 0.004 | inches | | | |

| Type/Code | P1 | P2 | D0 | Т | Unit |
|-----------|-----------------|-----------------|-------------------|-------------------|--------|
| RAF052D | 0.079 ± 0.002 | 0.079 ± 0.002 | 0.059 ± 0.004 | 0.020 ± 0.004 | inches |
| KAF032D | 2.00 ± 0.05 | 2.00 ± 0.05 | 1.50 ± 0.10 | 0.50 ± 0.10 | mm |
| RAF054D | 0.079 ± 0.002 | 0.079 ± 0.002 | 0.059 ± 0.004 | 0.020 ± 0.004 | inches |
| KAF034D | 2.00 ± 0.05 | 2.00 ± 0.05 | 1.50 ± 0.10 | 0.50 ± 0.10 | mm |

Resistive Product Solutions

RoHS Compliance

Stackpole Electronics has joined the worldwide effort to reduce the amount of lead in electronic components and to meet the various regulatory requirements now prevalent, such as the European Union's directive regarding "Restrictions on Hazardous Substances" (RoHS 3). As part of this ongoing program, we periodically update this document with the status regarding the availability of our compliant components. All our standard part numbers are compliant to EU Directive 2011/65/EU of the European Parliament as amended by Directive (EU) 2015/863/EU as regards the list of restricted substances.

| | RoHS Compliance Status | | | | | | | | | |
|-------------------------------|--|----------------------------------|---|--------------------------------------|--|--|--|--|--|--|
| Standard Product Series | Description | Package / Termination Type | Standard Series RoHS Compliant | Lead-Free Termination Composition | Lead-Free Mfg. Effective Date (Std Product Series) | Lead-Free Effective Date Code (YY/WW) | | | | |
| RAF | Thick Film Surface Mount Chip Resistor Array Flat Terminations | SMD | YES(1) | 100% Matte Sn over Ni | Jul-04 | 04/27 | | | | |

Note (1): RoHS Compliant by means of exemption 7c-I.

"Conflict Metals" Commitment

We at Stackpole Electronics, Inc. are joined with our industry in opposing the use of metals mined in the "conflict region" of the eastern Democratic Republic of the Congo (DRC) in our products. Recognizing that the supply chain for metals used in the electronics industry is very complex, we work closely with our own suppliers to verify to the extent possible that the materials and products we supply do not contain metals sourced from this conflict region. As such, we are in compliance with the requirements of Dodd-Frank Act regarding Conflict Minerals.

Compliance to "REACH"

We certify that all passive components supplied by Stackpole Electronics, Inc. are SVHC (Substances of Very High Concern) free and compliant with the requirements of EU Directive 1907/2006/EC, "The Registration, Evaluation, Authorization and Restriction of Chemicals", otherwise referred to as REACH. Contact us for complete list of REACH Substance Candidate List.

Environmental Policy

It is the policy of Stackpole Electronics, Inc. (SEI) to protect the environment in all localities in which we operate. We continually strive to improve our effect on the environment. We observe all applicable laws and regulations regarding the protection of our environment and all requests related to the environment to which we have agreed. We are committed to the prevention of all forms of pollution.

